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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re application of: Nguyen

Attorney Docket No.: LAM1P155D1

Application No.: 10/802,647

Examiner: Kornakov, Michail

Filed: March 16, 2004

Group: 1746

Title: METHOD AND APPARATUS FOR  
REDUCING He BACKSIDE FAULTS  
DURING WAFER PROCESSING

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**CERTIFICATE OF FACSIMILE TRANSMISSION**

I hereby certify that this correspondence is being transmitted by facsimile to fax number 571-273-1303 to the U.S. Patent and Trademark Office on November 10, 2004.

Signed: 

Quin C. Hoellwarth

*PVE* **AMENDMENT (A)**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Please enter the following amendments and remarks.

Amendments to the Claims are reflected in the Listing of Claims which begins on page 2 of this paper.

Amendments to the Specification begins on page 7 of this paper.

Remarks begin on page 8 of this paper.

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